



## 100V N-Channel SGT Power MOSFET

### General Description

The SJ016N10 uses SGT technology to provide excellent  $R_{DS(on)}$ , low gate charge and fast switching characteristics. This device is suitable for use as a wide variety of applications.

### Features

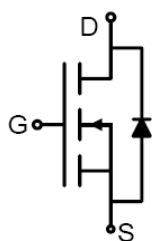
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

### Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

### Key Performance Parametes

Parameter	Value	Unit
$V_{DS}$	100	V
$R_{DS(ON\_TYP)}$	1.65	m $\Omega$
$I_D$	289	A
$Q_G$	150	nC



Schematic Diagram



TO-220 top view



### Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJ016N10	SJ016N10	TO-220	Tube	\	\	1000 Pcs

**Table 1. Absolute Maximum Ratings ( $T_C=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0\text{V}$ )	100	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0\text{V}$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_C=25^{\circ}\text{C}$ )	289	A
	Drain Current-Continuous( $T_C=100^{\circ}\text{C}$ )	183	A
$I_{DM}(\text{pulse})$	Drain Current-Continuous@ Current-Pulsed (Note 1)	1156	A
$P_D$	Maximum Power Dissipation( $T_C=25^{\circ}\text{C}$ )	284	W
	Maximum Power Dissipation( $T_C=100^{\circ}\text{C}$ )	114	W
$E_{AS}$	Avalanche energy (Note 2)	2500	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}\text{C}$

**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.44	$^{\circ}\text{C/W}$



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**Table 3. Electrical Characteristics ( $T_J=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	100			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V T <sub>J</sub> =25℃			1	μA
		V <sub>DS</sub> =100V, V <sub>GS</sub> =0V T <sub>J</sub> =125℃			100	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	2		4	V
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =20A		44		S
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =20A T <sub>J</sub> =25℃		1.65	2.1	mΩ
Dynamic Characteristics						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =50V, V <sub>GS</sub> =0V, f=1.0MHz		10500		pF
C <sub>oss</sub>	Output Capacitance			3740		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			60		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz		1.1		Ω
Switching Parameters						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> =10V, V <sub>DS</sub> =50V, R <sub>L</sub> =2.5Ω, R <sub>GEN</sub> =6Ω		36		nS
t <sub>r</sub>	Turn-on Rise Time			25		nS
t <sub>d(off)</sub>	Turn-Off Delay Time			90		nS
t <sub>f</sub>	Turn-Off Fall Time			40		nS
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> =10V, V <sub>DS</sub> =50V, I <sub>D</sub> =20A		150		nC
Q <sub>gs</sub>	Gate-Source Charge			48		nC
Q <sub>gd</sub>	Gate-Drain Charge			30		nC
Source-Drain Diode Characteristics						
I <sub>SD</sub>	Source-Drain Current (Body Diode)				289	A
V <sub>SD</sub>	Forward on Voltage (Note 3)	V <sub>GS</sub> =0V, I <sub>S</sub> =20A			1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> =20A, dI/dt=500A/μs		55		ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> =20A, dI/dt=500A/μs		333		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

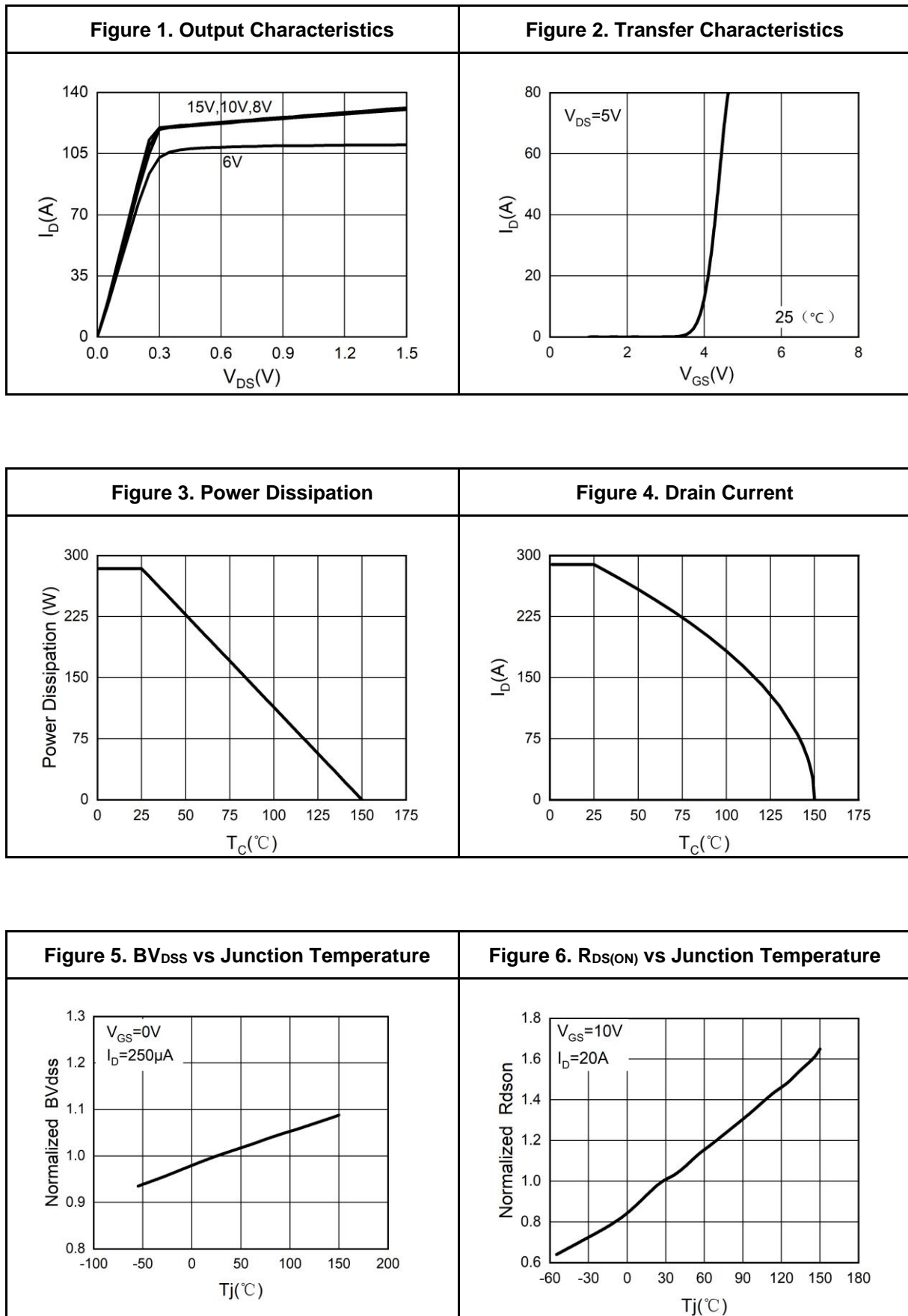
Notes 2. $E_{AS}$  condition:  $T_J=25^{\circ}\text{C}$ ,  $V_{DD}=50V$ ,  $V_G=10V$ ,  $R_g=25\Omega$ ,  $L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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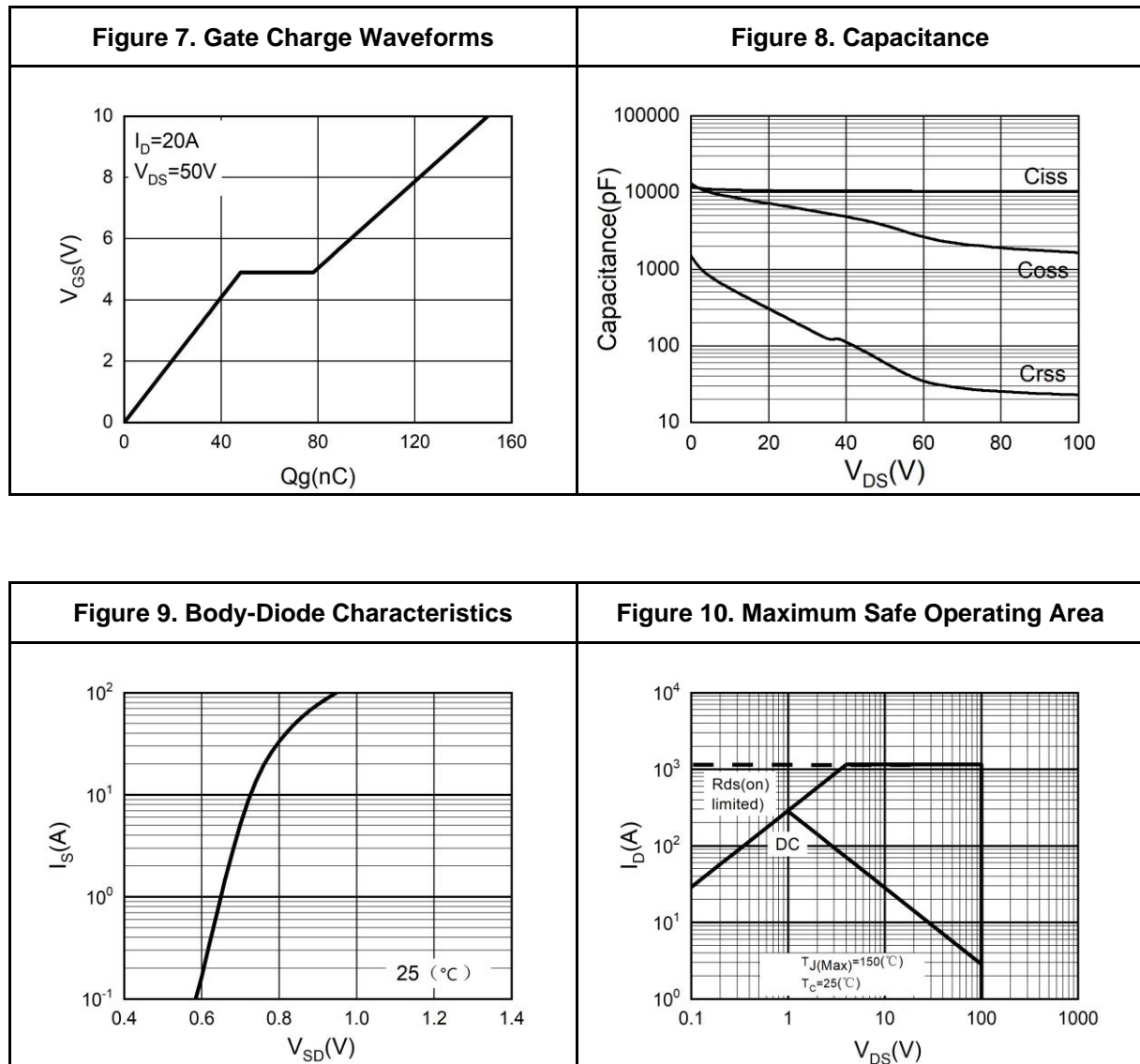
### Typical Electrical And Thermal Characteristics (Curves)





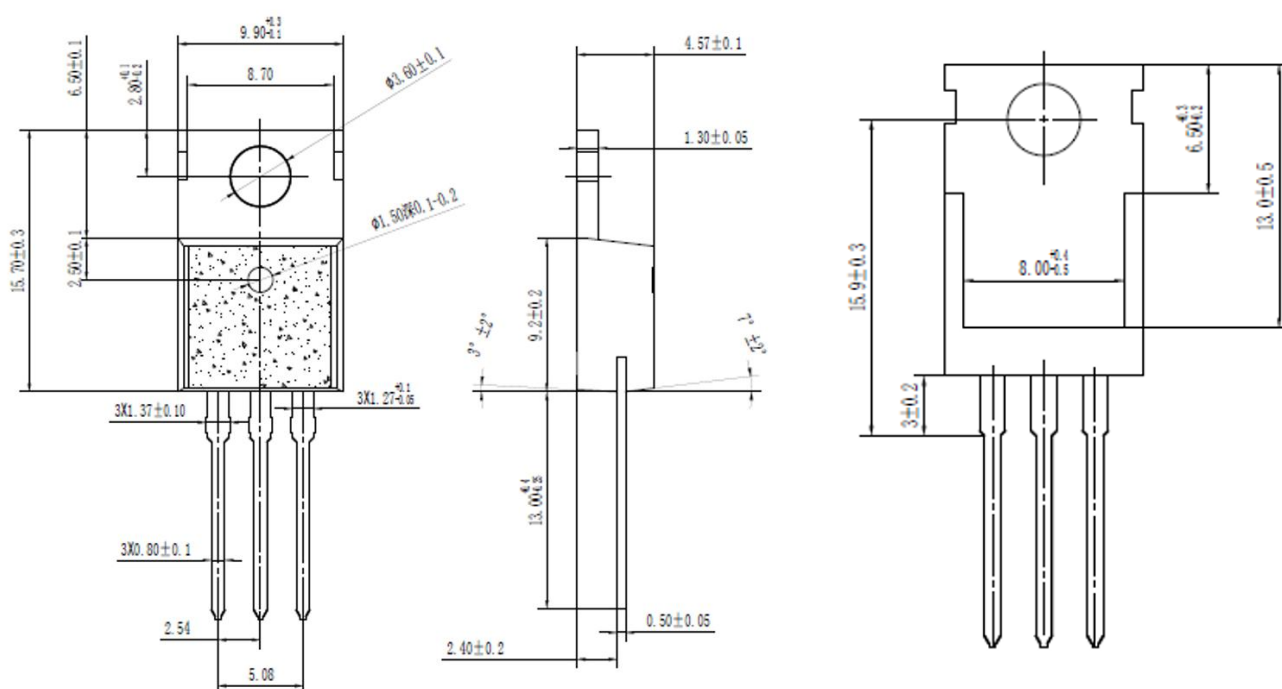
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### Typical Electrical And Thermal Characteristics (Curves)





## TO-220 Package Information





## **Attention**

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